

# DATASHEET

**Product Name**    **High-Power Thick Film Chip Resistors**

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**Part Name**    **HP Series**

**File No.**    **SMD-SP-003**

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Royal Technology (Thailand) Co., Ltd.

## 1. Scope

- 1.1 This datasheet is the characteristics of High Power Thick Film Chip Resistors manufactured by UNI-ROYAL.
- 1.2 High power standard size
- 1.3 Suitable for both wave & re-flow soldering
- 1.4 AEC-Q200 qualified
- 1.5 Application: AV adapters, LCD back-light, camera strobe ect.
- 1.6 Compliant with RoHS directive.
- 1.7 Halogen free requirement.

## 2. Part No. System

Part No. includes 14 codes shown as below:

2.1 1<sup>st</sup>~4<sup>th</sup> codes: Part name. E.g.: HP02、HP03、HP05、HP06、HP07、HP10、HP11、HP12

2.2 5<sup>th</sup>~6<sup>th</sup> codes: Power rating.

E.g.: W=Normal Size		“1~G” = “1~16”						
Wattage	3/4	1/2	1/3	1/5	1/10	1	1.25	2
Normal Size	07	W2	W3	W5	WA	1W	1Q	2W

If power rating is equal or lower than 1 watt, 5<sup>th</sup> code would be “W” and 6<sup>th</sup> code would be a number or letter.

E.g.: WA=1/10W

W3=1/3W

2.3 7<sup>th</sup> code: Tolerance. E.g.: D= ±0.5%

F=±1%

J=±5%

2.4 8<sup>th</sup>~11<sup>th</sup> codes: Resistance Value.

2.4.1 If value belongs to standard value of E-24 series, the 8<sup>th</sup> code is zero, 9<sup>th</sup>~10<sup>th</sup> codes are the significant figures of resistance value, and the 11<sup>th</sup> code is the power of ten.

2.4.2 If value belongs to standard value of E-96 series, the 8<sup>th</sup>~10<sup>th</sup> codes are the significant figures of resistance value, and the 11<sup>th</sup> code is the power of ten.

2.4.3 11<sup>th</sup> codes listed as following:

0=10<sup>0</sup> 1=10<sup>1</sup> 2=10<sup>2</sup> 3=10<sup>3</sup> 4=10<sup>4</sup> 5=10<sup>5</sup> 6=10<sup>6</sup> J=10<sup>-1</sup> K=10<sup>-2</sup> L=10<sup>-3</sup> M=10<sup>-4</sup>

2.5 12<sup>th</sup>~14<sup>th</sup> codes.

2.5.1 12<sup>th</sup> code: Packaging Type. E.g.: T=Tape/Reel

2.5.2 13<sup>th</sup> code: Standard Packing Quantity.

4=4,000pcs

5=5,000pcs

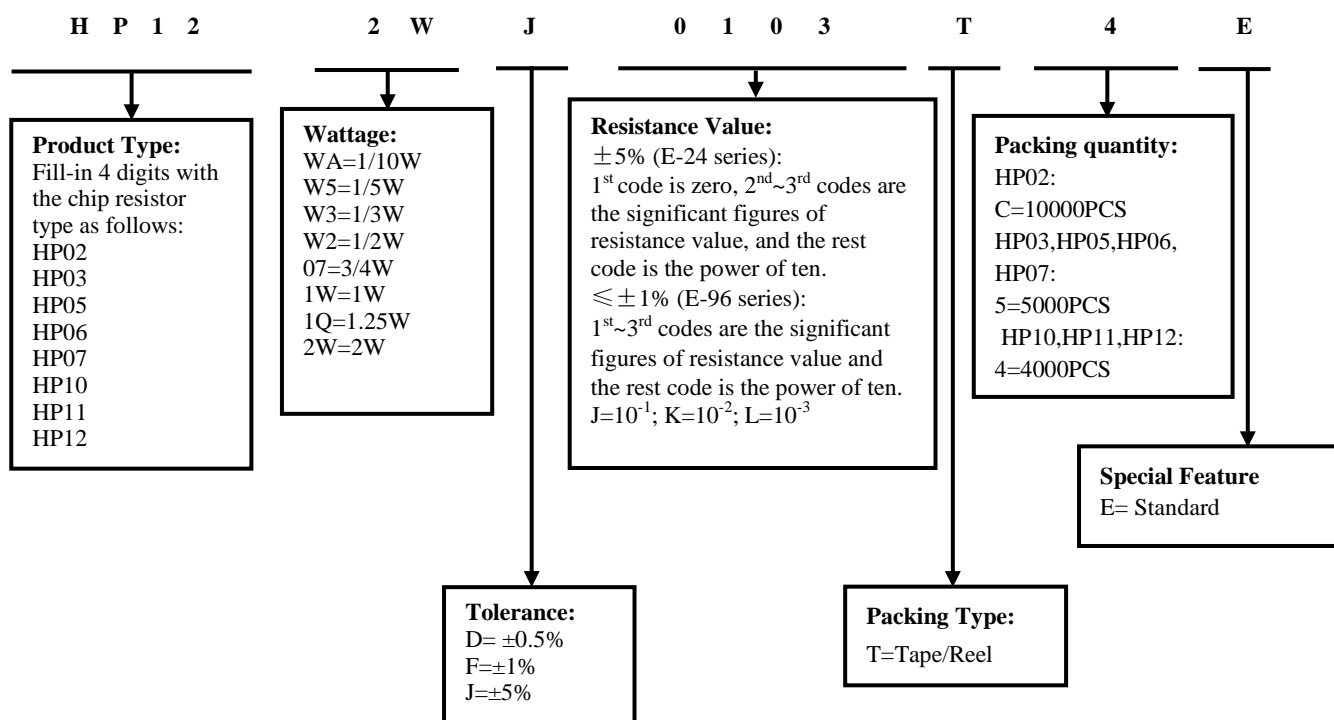
C=10,000pcs

2.5.3 14<sup>th</sup> code: Special features.

E = Standard

## 3. Ordering Procedure

(Example: HP12 2W ±5% 10KΩ T/R-4000)



## 4. Marking

4.1 For HP02 size. Due to the very small size of the resistor's body, there is no marking on the body.

4.2 Normally, the making of 0Ω HP03, 0Ω HP05, 0Ω HP06, 0Ω HP07, 0Ω HP10, 0Ω HP11, 0Ω HP12 resistors as following

4.3 ±5% tolerance products (E-24 series):

3 codes.

1<sup>st</sup>~2<sup>nd</sup> codes are the significant figures of resistance value, and the rest code is the power of ten.

4.4 ±0.5%, ±1% tolerance products (E-96 series):

4 codes.

1<sup>st</sup>~3<sup>rd</sup> codes are the significant figures of resistance value, and the rest code is the power of ten.

Letter "R" in mark means decimal point.

4.5 More than HP05 specifications (including) 4 digits, Product below 1Ω, show as following, the first digit Is "R" which as decimal point.



0 → 0Ω



333 → 33KΩ



2701 → 2.7KΩ



R300 → 0.3Ω

4.6 Standard E-96 series values of HP03 ≤ ±1% : due to the small size of the resistor's body, 3 digits marking will be used to indicate the accurate resistance value by using the following multiplier & resistance code.

Multiplier Code (for HP03 ≤ ±1% marking)

Code	A	B	C	D	E	F	G	H	X	Y	Z
Multiplier	10 <sup>0</sup>	10 <sup>1</sup>	10 <sup>2</sup>	10 <sup>3</sup>	10 <sup>4</sup>	10 <sup>5</sup>	10 <sup>6</sup>	10 <sup>7</sup>	10 <sup>-1</sup>	10 <sup>-2</sup>	10 <sup>-3</sup>

Standard E-96 series Resistance Value code (for HP03 ≤ ±1% marking)

Value	Code	Value	Code	Value	Code	Value	Code
100	01	178	25	316	49	562	73
102	02	182	26	324	50	576	74
105	03	187	27	332	51	590	75
107	04	191	28	340	52	604	76
110	05	196	29	348	53	619	77
113	06	200	30	357	54	634	78
115	07	205	31	365	55	649	79
118	08	210	32	374	56	665	80
121	09	215	33	383	57	681	81
124	10	221	34	392	58	698	82
127	11	226	35	402	59	715	83
130	12	232	36	412	60	732	84
133	13	237	37	422	61	750	85
137	14	243	38	432	62	768	86
140	15	249	39	442	63	787	87
143	16	255	40	453	64	806	88
147	17	261	41	464	65	825	89
150	18	267	42	475	66	845	90
154	19	274	43	487	67	866	91
158	20	280	44	499	68	887	92
162	21	287	45	511	69	909	93
165	22	294	46	523	70	931	94
169	23	301	47	536	71	953	95
174	24	309	48	549	72	976	96

So the resistance value are marked as the following examples



$$1.96K\Omega = 196 \times 10^1 \Omega = 29B$$



$$12.4\Omega = 124 \times 10^{-1} \Omega = 10X$$

4.7 Standard E-24 and not belong to E-96 series values ( $\leq \pm 1\%$ ) of 0603 size: the marking is the same as 5% tolerance but marking as underline.



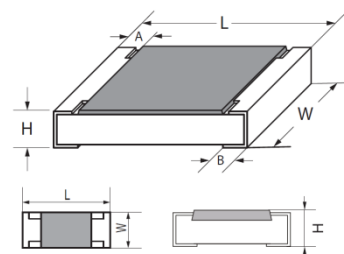
$$\underline{333} = 33K\Omega$$



$$\underline{680} = 68\Omega$$

## 5. Dimension

Type	Dimension(mm)				
	L	W	H	A	B
HP02(0402)	1.00±0.10	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
HP03(0603)	1.60±0.10	0.80±0.10	0.45±0.10	0.30±0.20	0.30±0.20
HP05(0805)	2.00±0.15	1.25±0.15/-0.10	0.55±0.10	0.40±0.20	0.40±0.20
HP06(1206)	3.10±0.15	1.55±0.15/-0.10	0.55±0.10	0.45±0.20	0.45±0.20
HP07(1210)	3.10±0.10	2.50±0.15	0.55±0.10	0.50±0.25	0.50±0.20
HP10(2010)	5.00±0.10	2.50±0.20	0.55±0.10	0.60±0.25	0.50±0.20
HP11(1812)	4.50±0.20	3.20±0.20	0.55±0.20	0.50±0.20	0.50±0.20
HP12(2512)	6.35±0.10	3.20±0.20	0.55±0.10	0.60±0.25	0.50±0.20



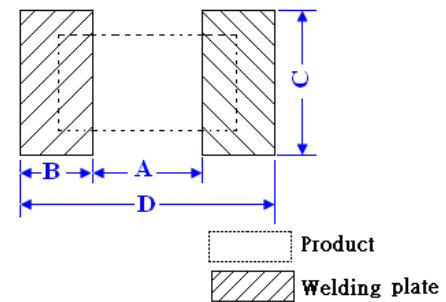
## 6. Resistance Range

Type	Power Rating	Resistance Range of 0.5%, 1%, 5%	Max. Working Voltage	Max. Overload Voltage	Dielectric withstanding Voltage	Operating Temperature
HP02(0402)	1/10W	1Ω~10M	50V	100V	100V	-55°C~155°C
HP03(0603)	1/5W	0.1Ω~10M	75V	150V	300V	
HP05(0805)	1/3W	0.01Ω~10M	150V	300V	500V	
HP06(1206)	1/2W	0.01Ω~10M	200V	400V	500V	
HP07(1210)	3/4W	0.1Ω~10M	200V	500V	500V	
HP10(2010)	1W	0.01Ω~10M	200V	500V	500V	
HP11(1812)	1.25W	0.1Ω~10M	200V	500V	500V	
HP12(2512)	2W	0.01Ω~10M	300V	500V	500V	

Type	Resistance Value of Jumper	Rated Current of Jumper	Max. Overload Current of Jumper
HP02(0402)	≤10mΩ	3A	6A
HP03(0603)	≤8mΩ	5A	10A
HP05(0805)	≤5mΩ	6A	12A
HP06(1206)	≤5mΩ	10A	20A
HP07(1210)	≤4mΩ	12A	24A
HP10(2010)	≤5mΩ	12A	24A
HP11(1812)	≤5mΩ	12A	24A
HP12(2512)	≤5mΩ	16A	32A

## 7. Soldering pad size recommended

Type	Dimension(mm)			
	A	B	C	D
HP02	0.5±0.05	0.5±0.05	0.6±0.05	1.5±0.05
HP03	0.8±0.05	0.8±0.05	0.9±0.05	2.4±0.05
HP05	1.0±0.1	1±0.1	1.4±0.1	3±0.1
HP06	2.0±0.1	1.1±0.1	1.8±0.1	4.2±0.1
HP07	2.0±0.1	1.1±0.1	2.9±0.1	4.2±0.1
HP10	3.6±0.1	1.4±0.1	3±0.1	6.4±0.1
HP11	3.0±0.1	1.4±0.1	3.7±0.1	5.8±0.1
HP12	4.9±0.1	1.35±0.1	3.7±0.1	7.6±0.1



## 8. Derating Curve

Power rating will change based on continuous load at ambient temperature from -55 to 155°C. It is constant between -55 to 70°C, and derate to zero when temperature rise from 70 to 155°C.

Voltage rating:

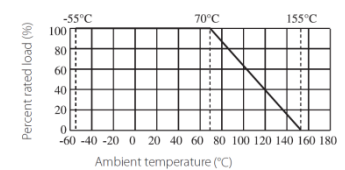
Resistors shall have a rated direct-current (DC) continuous working voltage or an approximate sine-wave root-mean-square (RMS) alternating-current (AC) continuous working voltage at commercial-line frequency and waveform corresponding to the power rating, as determined from the following formula:

$$RCWV = \sqrt{P \times R}$$

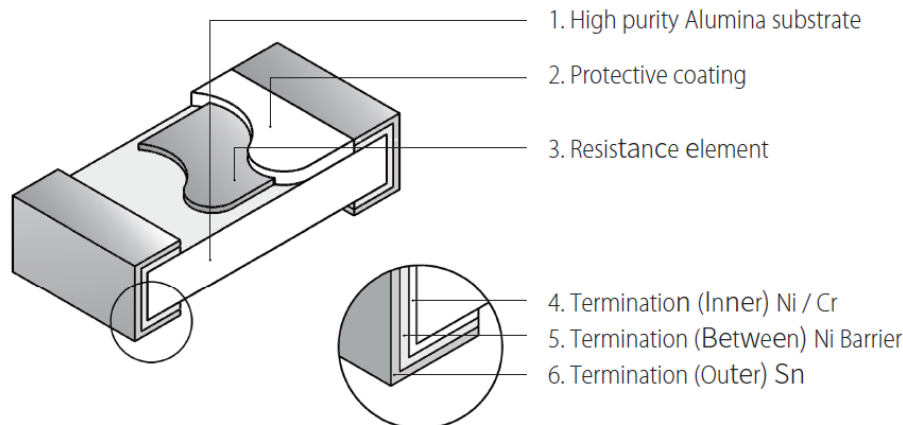
Remark: RCWV: Rating Continuous Working Voltage (Volt.) P: power rating (Watt) R: nominal resistance (Ω)

In no case shall the rated DC or RMS AC continuous working voltage be greater than the applicable maximum value.

The overload voltage is 2.5 times RCWV or Max. Overload voltage whichever is lower.



## 9. Structure



## 10. Performance Specification

Characteristic	Limits	Ref. Standards	Test Methods
Operational life	±0.5%, ±1%: ±(1.0%+0.1Ω) ±5%: ±(3.0%+0.1Ω)	MIL-STD-202 Method 108	70°C rated power, at RCWV or Max. Working Voltage whichever less, 1000h (1.5 hours "ON", 0.5 hour "OFF"). Measurement at 24±4hours after test conclusion.
	HP02: <20mΩ; HP03: <16 mΩ; HP05、HP06、HP10、HP11、HP12: <10 mΩ HP07: <8mΩ		Apply to rate current for 0 Ω
Electrical Characterization (T.C.R)	HP02: 1Ω≤R≤10Ω: ±400 PPM/°C 10Ω<R≤100Ω: ±200 PPM/°C 100Ω<R≤10M: ±100 PPM/°C HP03: 0.1Ω≤R<0.2Ω: ±200PPM/°C 0.2Ω≤R≤10M: ±100 PPM/°C	GB/T 5729 4.8 JIS-C-5201 4.8 IEC 60115-1 6.2	Natural resistance changes per temp. Degree centigrade $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6$ (PPM/°C) R <sub>1</sub> : Resistance Value at room temperature (t <sub>1</sub> );

	<p>HP05:  <math>10\text{m}\Omega \leq R \leq 15\text{m}\Omega</math>: <math>\pm 800\text{ppm}/^\circ\text{C}</math>  <math>15\text{m}\Omega &lt; R \leq 25\text{m}\Omega</math>: <math>\pm 600\text{ppm}/^\circ\text{C}</math>  <math>25\text{m}\Omega &lt; R \leq 50\text{m}\Omega</math>: <math>\pm 400\text{ppm}/^\circ\text{C}</math>  <math>50\text{m}\Omega &lt; R &lt; 0.1\Omega</math>: <math>\pm 200\text{ppm}/^\circ\text{C}</math>  <math>0.1\Omega \leq R \leq 10\text{M}</math>: <math>\pm 100\text{ppm}/^\circ\text{C}</math></p> <p>HP06:  <math>10\text{m}\Omega \leq R &lt; 15\text{m}\Omega</math>: <math>\pm 700\text{ppm}/^\circ\text{C}</math>  <math>15\text{m}\Omega \leq R &lt; 30\text{m}\Omega</math>: <math>\pm 400\text{ppm}/^\circ\text{C}</math>  <math>30\text{m}\Omega \leq R &lt; 50\text{m}\Omega</math>: <math>\pm 300\text{ppm}/^\circ\text{C}</math>  <math>50\text{m}\Omega \leq R &lt; 0.1\Omega</math>: <math>\pm 150\text{ppm}/^\circ\text{C}</math>  <math>0.1\Omega \leq R \leq 10\text{M}</math>: <math>\pm 100\text{ppm}/^\circ\text{C}</math></p> <p>HP10:  <math>10\text{m}\Omega \leq R &lt; 15\text{m}\Omega</math>: <math>0 \sim +800\text{ppm}/^\circ\text{C}</math>  <math>15\text{m}\Omega \leq R &lt; 50\text{m}\Omega</math>: <math>0 \sim +600\text{ppm}/^\circ\text{C}</math>  <math>50\text{m}\Omega \leq R &lt; 10\text{M}</math>: <math>\pm 100\text{ppm}/^\circ\text{C}</math></p> <p>HP07、HP11: <math>\pm 100\text{PPM}/^\circ\text{C}</math></p> <p>HP12:  <math>10\text{m}\Omega \leq R &lt; 20\text{m}\Omega</math>: <math>0 \sim +800\text{ppm}/^\circ\text{C}</math>  <math>20\text{m}\Omega \leq R \leq 50\text{m}\Omega</math>: <math>0 \sim +400\text{ppm}/^\circ\text{C}</math>  <math>50\text{m}\Omega &lt; R \leq 10\text{M}</math>: <math>\pm 100\text{ppm}/^\circ\text{C}</math></p>		<p><math>R_2</math>: Resistance at test temperature (<math>t_2</math>)  <math>t_1</math>: <math>+25^\circ\text{C}</math> or specified room temperature  <math>t_2</math>: Test temperature (<math>-55^\circ\text{C}</math> or <math>125^\circ\text{C}</math>)</p>
Short-time overload	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.1\Omega)$ $\pm 5\%: \pm (2.0\% + 0.1\Omega)$	GB/T 5729 4.13 JIS-C-5201 4.13 IEC 60115-1 8.1.4.2	Permanent resistance change after the application of a potential of 2.5 times RCWV or Max. Overload Voltage whichever less for 5 seconds..
	HP02: $\leq 10\text{m}\Omega$ ; HP03 $\leq 8\text{m}\Omega$ ; HP05、HP06、HP10、HP11、HP12: $\leq 5\text{m}\Omega$ HP07: $\leq 4\text{m}\Omega$		Apply max Overload current for 0 $\Omega$
External Visual	Marking Complete , no mechanical damage	MIL-STD-883 Method 2009	Electrical test not required. Inspect device construction, marking and workmanship
Physical Dimension	Reference 5 Dimension Standards	JESD22 MH Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical test not required.
Resistance to Solvent	Marking Complete , no mechanical damage	MIL-STD-202 Method 215	Note: Add Aqueous wash chemical – OKEM Clean or equivalent. Do not use banned solvents.
Terminal Strength	Not broken	AEC-Q200-006	HP02: 5N; others: 17.7N, $60 \pm 1$ seconds.
High Temperature Exposure (Storage)	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.1\Omega)$ $\pm 5\%: \pm (3.0\% + 0.1\Omega)$	MIL-STD-202 Method 108	Upper Temperature. 1000hrs. Unpowered. Measurement at $24 \pm 4$ hours after test conclusion.
	HP02: $\leq 10\text{m}\Omega$ ; HP03 $\leq 8\text{m}\Omega$ ; HP05、HP06、HP10、HP11、HP12: $\leq 5\text{m}\Omega$ HP07: $\leq 4\text{m}\Omega$		
Temperature Cycling	$\pm (1.0\% + 0.05\Omega)$	JESD22 Method JA-104	1000 Cycles ( $-55^\circ\text{C}$ to $+155^\circ\text{C}$ ). Measurement at $24 \pm 4$ hours after test conclusion.
	HP02: $\leq 10\text{m}\Omega$ ; HP03 $\leq 8\text{m}\Omega$ ; HP05、HP06、HP10、HP11、HP12: $\leq 5\text{m}\Omega$ HP07: $\leq 4\text{m}\Omega$		
Biased Humidity	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.05\Omega)$ $\pm 5\%: \pm (3.0\% + 0.05\Omega)$	MIL-STD-202 Method 103	1000 hours $85^\circ\text{C}$ , 85% RH. Note: Specified conditions: 10% of operating power. Measurement at $24 \pm 4$ hours after test conclusion.
	HP02: $\leq 10\text{m}\Omega$ ; HP03 $\leq 8\text{m}\Omega$ ; HP05、HP06、HP10、HP11、HP12: $\leq 5\text{m}\Omega$ HP07: $\leq 4\text{m}\Omega$		Apply to rate current for 0 $\Omega$
Mechanical Shock	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.1\Omega)$ $\pm 5\%: \pm (2.0\% + 0.1\Omega)$	MIL-STD-202 Method 213	Half sine wave, acceleration 100g's, each three times in X, Y and Z directions, pulse width 6ms.
	HP02: $\leq 10\text{m}\Omega$ ; HP03 $\leq 8\text{m}\Omega$ ; HP05、HP06、HP10、HP11、HP12: $\leq 5\text{m}\Omega$ HP07: $\leq 4\text{m}\Omega$		

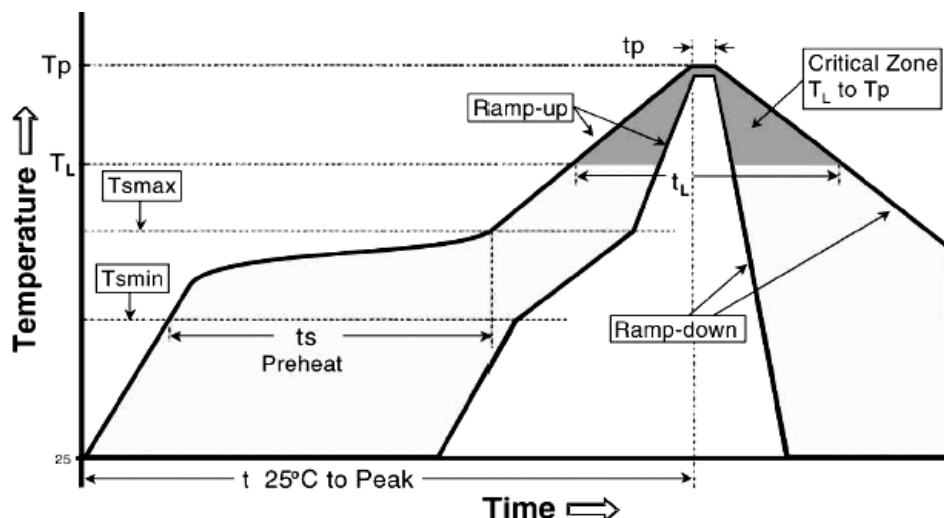


Vibration	$\pm 0.5\%, \pm 1\%: \pm (1.0\% + 0.1\Omega)$ $\pm 5\%: \pm (2.0\% + 0.1\Omega)$	MIL-STD-202 Method 204	5g's for 20 min., 12cycle each of 3 orientations. Note: Use 8"×5"PCB. 031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2' from any secure point. Test from 10-2000Hz.
	HP02: $\leq 10m\Omega$ ; HP03: $\leq 8m\Omega$ ; HP05, HP06, HP10, HP11, HP12: $\leq 5m\Omega$ HP07: $\leq 4m\Omega$		
ESD	$\pm (3.0\% + 0.1\Omega)$	AEC-Q200-002	With the electrometer in direct contact with the discharge tip, verify the voltage setting at levels of $\pm 500V, \pm 1KV, \pm 2KV, \pm 4KV, \pm 8KV$ . The electrometer reading shall be within $\pm 10\%$ for voltages from 500V to $\leq 800V$ .
Solderability	Coverage must be over 95%.	J-STD-002	For both leaded & SMD. Electrical test not required. Magnification 50X. Conditions: a) Method B 4hrs at $155^\circ C$ dry heat, the dip in bath with $245 \pm 3^\circ C, 5 \pm 0.5s$ . b) Method D: at $260 \pm 3^\circ C, 30 \pm 0.5s$ .
Flammability	No ignition of the tissue paper or scorching or the pinewood board	UL-94	V-0 or V-1 are acceptable. Electrical test not required.
Board Flex	$\pm (1.0\% + 0.05\Omega)$	AEC-Q200-005	Bending 2mm(min) for 60+5sec
	HP02: $\leq 10m\Omega$ ; HP03: $\leq 8m\Omega$ ; HP05, HP06, HP10, HP11, HP12: $\leq 5m\Omega$ HP07: $\leq 4m\Omega$		
Flame Retardance	No flame	AEC-Q200-001	Only requested, when voltage/power will increase the surface temp to $350^\circ C$ . Apply voltage from 9V to 32V. No flame; No explosion.
Resistance to Soldering Heat	$\pm (1.0\% + 0.05\Omega)$	MIL-STD-202 Method 210	Condition B No per-heat of samples. Dipping the resistor into a solder bath having a temperature of $260^\circ C \pm 5^\circ C$ and hold it for $10 \pm 1$ seconds
	HP02: $\leq 10m\Omega$ ; HP03: $\leq 8m\Omega$ ; HP05, HP06, HP10, HP11, HP12: $\leq 5m\Omega$ HP07: $\leq 4m\Omega$		

## 11. Soldering Condition

(This is for recommendation, please customer perform adjustment according to actual application)

11.1 Recommend Reflow Soldering Profile : (solder : Sn96.5 / Ag3 / Cu0.5)

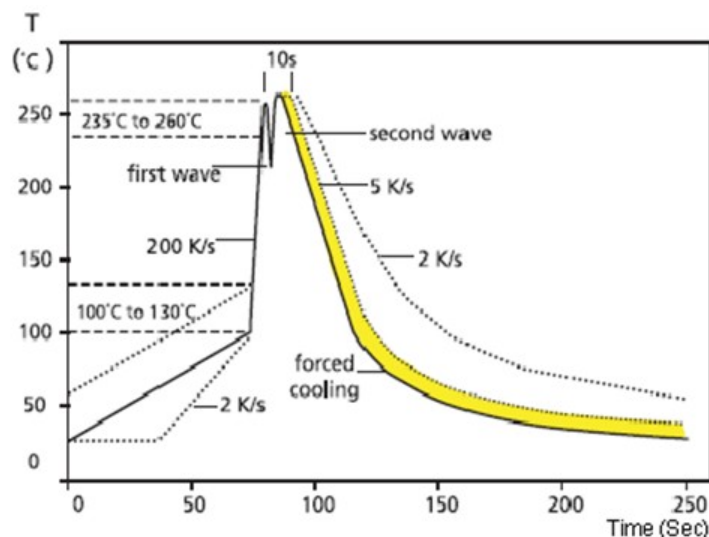


Profile Feature	Lead (Pb)-Free solder
Preheat: Temperature Min ( $T_{s_{min}}$ ) Temperature Max ( $T_{s_{max}}$ ) Time ( $T_{s_{min}}$ to $T_{s_{max}}$ ) (ts)	150°C 200°C 60 -120 seconds
Average ramp-up rate : ( $T_{s_{max}}$ to $T_p$ )	3°C / second max.
Time maintained above : Temperature ( $T_L$ ) Time ( $t_L$ )	217°C 60-150 seconds
Peak Temperature ( $T_p$ )	260°C
Time within $+0_{-5}^{\circ}\text{C}$ of actual peak Temperature ( $t_p$ ) <sup>2</sup>	10 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8minutes max.

Allowed Re-flow times : 2 times

Remark : To avoid discoloration phenomena of chip on terminal electrodes, we suggest use  $N_2$  Re-flow furnace .

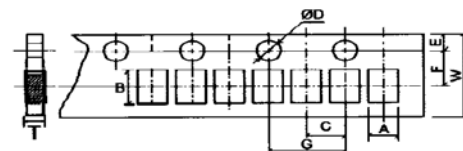
11.2 Recommend Wave Soldering Profile : (Apply to 0603 and above size)



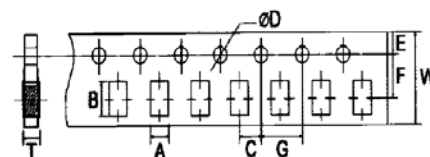
## 12. Packing

12.1 Dimension of Paper Taping :(Unit: mm)

Type	A ±0.1	B ±0.1	C ±0.05	$\Phi D^{+0.1}_{-0}$	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.05
HP02	0.65	1.20	2.00	1.50	1.75	3.5	4.00	8.0	0.42



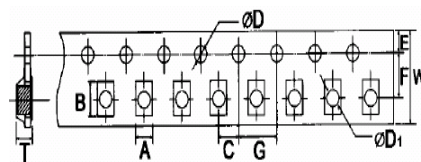
TYPE	A ±0.2	B ±0.2	C ±0.05	$\Phi D^{+0.1}_{-0}$	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.10
HP03	1.10	1.90	2.00	1.50	1.75	3.5	4.00	8.00	0.67
HP05	1.65	2.40	2.00	1.50	1.75	3.5	4.00	8.00	0.81
HP06	2.00	3.60	2.00	1.50	1.75	3.5	4.00	8.00	0.81
HP07	2.80	3.50	2.00	1.50	1.75	3.5	4.00	8.00	0.75





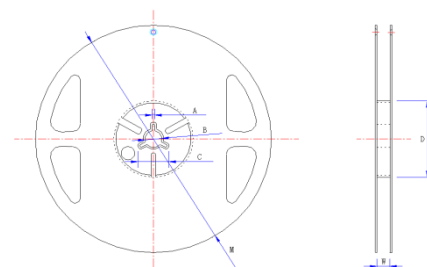
## 12.2 Dimension of plastic taping: (Unit: mm)

Type	A ±0.2	B ±0.2	C ±0.05	ΦD <sup>+0.1</sup> <sub>-0</sub>	ΦD1 <sup>+0.25</sup> <sub>-0</sub>	E ±0.1	F ±0.05	G ±0.1	W ±0.2	T ±0.1
HP10	2.9	5.6	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
HP11	3.5	4.8	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0
HP12	3.5	6.7	2.0	1.5	1.5	1.75	5.5	4.0	12.0	1.0



## 12.3 Dimension of Reel : (Unit: mm)

Type	Taping	Qty/Reel	A±0.5	B±0.5	C±0.5	ΦD±1	ΦL±2	W±1
HP02	Paper	10,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP03	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP05	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP06	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP07	Paper	5,000pcs	2.0	13.0	21.0	60.0	178.0	10.0
HP10	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8
HP11	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8
HP12	Embossed	4,000pcs	2.0	13.0	21.0	60.0	178.0	13.8



## 13. Note

13.1. UNI-ROYAL recommend the storage condition temperature: 15℃~35℃, humidity :25%~75%.

(Put condition for individual product).Even under UNI-ROYAL recommended storage condition, solderability of products over 1 year old.

(Put condition for each product) may be degraded.

13.2. Store / transport cartons in the correct direction, which is indicated on a carton as a symbol.

Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

13.3. Product performance and soldered connections may deteriorate if the products are stored in the following places:

- Storage in high Electrostatic.
- Storage in direct sunshine 、rain and snow or condensation.
- Where the products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S<sub>3</sub> NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>2</sub>, Br etc.

## 14. Record

Version	Description	Page	Date	Amended by	Checked by
1	First version	1~8	May.22, 2020	Haiyan Chen	Yuhua Xu
2	1.Add 0603 Marking	3~4	Sep.19, 2022	Haiyan Chen	Yuhua Xu
	2. Add 0Ω the greater than the Max Overload Curren	4			
	3. Modify terminal strength test conditions	6			
3	Modify ESD test	7	Feb.19, 2024	Song Nie	Haiyan Chen
4	Modify temperature cycling test	5	Aug.10, 2024	Haiyan Chen	Yuhua Xu
5	The IEC60115 reference standard is modified	6	Oct.30, 2024	Haiyan Chen	Yuhua Xu
6	1.Add the ±0.5% tolerance	2,4	Apr.17, 2025	Haiyan Chen	Yuhua Xu
	2.Modify the "W" dimension of HP07	4			
7	Modify Performance Specification	6	Jan.08, 2026	Xiaoli Liu	Haiyan Chen

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